HIGH TEMPERATURE CERAMIC & GRAPHITE ADHESIVES

Our high temperature ceramic and graphite adhesives are unique formulations for bonding, potting and sealing ceramics, composites, graphite, metals, quartz, and semiconductors for applications to 3200 °F (1760°C).

TYPICAL APPLICATIONS

Electrical

- Halogen Lamps
- Heaters
- Igniters
- Fiberoptics
- Resistors
- Solid Oxide Fuel Cells

Instruments & Sensors

- Gas Chromatographs
- · High Vacuum Components
- Liquid Metal Inclusion Counters
- Mass Spectrometers
- Oxygen Analyzers
- Strain Gauges
- Semiconductors
- Temperature Probes

Mechanical

- Ceramic Honeycombs
- Ceramic Textiles
- · Graphite Blocks
- · Refractory Insulation
- Sagger Plates
- Thread-Locking



Ceramabond™ 685-N bonds ceramic honeycomb to infrared heater.



Ceramabond™ 835-M bonds halogen lamp.



Ceramabond™ 503 coats heater used to 1700 °C.



Ultra-Temp $^{\text{TM}}$ 516 bonds thermocouple to quartz tube.



Ultra-Temp™ 516 seals heater assembly.



Graphi-Bond™ 551-RN bonds graphite blocks.

PART NO.	FILLER	BONDING *	PRINCIPAL USE							
503		C-C	Dense Ceramics; Alumina-to-Alumina							
552		C-C, C-M	Solid Oxide Fuel Cells; Low CTE Metals							
569	- Al ₂ O ₃	C-C, C-M, Quartz	Heaters, Igniters, Resistors, Sensors							
670		C-C, C-M	Ceramic Textiles, Thread-Locking							
671		C-C, C-M, M-M	Ceramic Textiles, Thread-Locking							
835-M		C-C, C-M, Quartz	Halogen Lamps							
835-MB		C-C, C-M, Quartz	Halogen Lamps							
813-A		C-C, C-M	Tundish Nozzles							
865	AIN	C-C, C-M	Probes & Sensors; Thermal Conductivity							
600		C-C, C-M	Refractory Repair							
668	Al ₂ O ₃ – SiO ₂	C-C, C-M	Oxygen Sensors, Heaters							
677		C-C	Refractory Board							
690	BN	C-C	Boron Nitride; Thermal Conductivity							
551-RN	Graphite	Graphite, Carbon	Reducing/Vacuum Atmosphere							
669	Grapinte	Graphite	Oxidizing Atmosphere							
571	MgO	C-M, M-M	Heaters, Induction Coils, Sensors							
632	Mica	Mica	Mica Heaters							
618-N	SiO ₂	C-C, Quartz	Porous Ceramics, Quartz Tubes							
516		C-C, C-M	Thermocouples, Semiconductor Wafers							
685-N	ZrO ₂	C-C, C-M	Gasketing, Heaters, Igniters							
835	2102	C-C, C-M	Halogen Lamps							
885		C-C	Zirconia, Solid Oxide Fuel Cells							
890	SiC	C-C	Crucibles, Heaters, Sagger Plates							

		HIGH T	EMPERA	TURE CE	RAMIC &	GRAPHI	TE ADHE	SIVES PI	ROPERTI	ES				
		503	552	569	670	671	813-A	835-M	835-MB	600-N	668	677		
Trac	lename	Ceramabond™	Ceramabond™	Ceramabond™	Ceramabond™	Ceramabond™	Ceramabond™	Ceramabond™	Ceramabond™	Pyro-Putty™	Ceramabond™	Pyro-Putty™		
Maj	or Constituent				Al ₂ () ₃					Al ₂ O ₃ - SiO ₂			
Color		White	White	White	White	White	White	White	White	Tan	White	Tan		
No.	Components	1	1	1	1	1			1	1				
Viso	cosity, cP	50,000 - 90,000	53,000 - 73,000	Paste	2,500 - 5,000	40,000 - 80,000	50,000 - 80,000	30,000 - 40,000	40,000 - 80,000	5,000 - 15,000	40,000 - 80,000	15,000 - 25,000		
Specific Gravity, g/cc		Specific Gravity, g/cc		2.35 - 2.55	1.90 - 2.20	2.15 - 2.30	1.80 - 1.95	2.05 - 2.15	2.00 - 2.10	2.35 - 2.45	2.00 - 2.15	2.00 - 2.05	2.20-2.40	1.90 - 2.10
Temperature Limit, °F (°C)		3000 (1650)	3000 (1650)	3000 (1650)	3000 (1650)	3200 (1760)	3000 (1650)	3000 (1650)	3000 (1650)	3000 (1650)	2500 (1371)	1) 2400 (1316)		
CTE	, in/in/°F x 10 ⁻⁶ (°C)	4.0 (7.2)	4.3 (7.7)	4.2 (7.6)	4.3 (7.7)	4.3 (7.7)	4.0 (7.2)	4.0 (7.2)	3.8 (6.8)	3.0 (5.4)	4.0 (7.2)	4.1 (7.4)		
	Mix Ratio, powder:liquid	N/A	N/A	N/A	N/A	N/A	N/A	N/A	100 : 60-80	N/A	N/A	N/A		
	Thinner	503-T	552-T	52-T 569-T 670-T 671-T 813-A-T 835-M-T		835-M-T	835-MB-T	600-T	668-T	677-T				
Handling	Solvent	Water	Water	Water	Water	Water	Water	Water	Water	Water	Water	Water		
Han	Application Temperature, °F	50-90	50-90	50-90	50-90	50-90	50-90	50-90	50-90	50-90	50-90	50-90		
	Storage Temperature, °F	40-90	40-90	40-90	40-90	40-90	40-90	40-90	40-90	40-90	40-90	40-90		
	Shelf Life, Months	6	6	6	6	6	6	6	6	6	6	6		
	Air Set, Hours	<= 1	1-4	1-4	1-4	1-4	1-4	1-4	1-4	1-4	1	1-4		
Curing	Heat Cure, °F, Hrs	200, 2 + 500, 2 + 700, 2	200, 2 + 500, 2	200, 2	200, 2	200, 2	200, 2	200, 2	200, 2 + 350, 2 + 500, 2	200, 2 + 350, 1	200, 1-4	200, 2		
Dielectric Strength, volts/mil @ RT(@ 1000 °F)		171	173	138	142	182	136	163	202	203	118	118		
Torque Strength, ft-lbs ①		60	52	38	60	57	27	63	27	14	38	N/M		
Torque Strength, ft-lbs ① Moisture Resistance ②		Good	Excellent	Excellent	Excellent	Excellent	Excellent	Good	Good	Excellent	Excellent	Excellent		
Alka	ali Resistance ②	Fair	Good	Good	Good	Excellent	Excellent	Excellent	Excellent	Good	Excellent	Good		
Acid	l Resistance ②	Excellent	Good	Excellent	Good	Good	Good	Good	Good	Good	Good	Good		

Footnotes

- © Tested using a torque wrench after bonding a 1/2"-13 nut and bolt and curing at 200 °F for 5 hours.

 ② Properties were evaluated after curing at 700 °F for 2 hours.

 ③ Ceramabond™ 690 operates to 1560 °F in an oxidizing atmosphere and 2700 °F in an inert or vacuum atmosphere.

 ④ Graphi-Bond™ 551-RN is also offered in a two-part, resin and powder, system called 551-RN-X for international shipments of 1 gallon or more.

Abbreviations

N/A - Not Applicable N/M - Not Measured

General Notes

- All adhesives except 551-RN contain no volatile organic compounds (VOCs).
- Special pigments available upon request.
 Some adhesives including 503, 516, 553, 569, 571, 618-N, and 890 can be formulated using 1-5 micron ceramic powders. Add "-VFG" to the part number (ex. 503-VFG) and contact Aremco for special pricing.

		HIGH	TEMPE	RATURE	CERAM	IC & GR/	APHITE /	ADHESIV	/ES PRO	PERTIES	3			
		865	690	551-RN [®]	669	571	632	618-N	890	516	685-N	835	885	
Tradename		Ceramabond™	Ceramabond™	Graphi-Bond™ Graphi-Bond™		Ceramabond™	Ceramabond™	Ceramabond™	Ceramabond™	Ceramabond™	Ceramabond™	Ceramabond™	Ceramabond™	
Maj	or Constituent	AIN	BN	Graphite		MgO	Mica	SiO ₂	SiC		ZrO ₂ -	ZrSiO ₄		
Colo	r	Grey	White	Black	Black	Off-White	Tan	Off-White	Blue-Gray	Tan	Tan	Tan	Tan	
No.	Components	1	1	1	1	2	1	1	1	1	1	1	1	
Viscosity, cP		Paste	Paste	Paste	20,000 - 40,000	20,000 - 10,000 - 25,000		40,000 - 60,000	35,000 - 55,000	40,000 - 70,000	5,000 - 20,000	20,000 - 40,000	10,000 - 20,000	
Spe	cific Gravity, g/cc	1.95 - 2.15	0.95 - 1.05	1.45 - 1.50	1.45 - 1.50	1.90 - 2.20	1.90 - 2.20		1.70 - 1.75	2.15 - 2.30	1.85 - 1.95	2.25 - 2.35	2.65 - 2.70	
Temperature Limit, °F (°C)		3000 (1650)	1560 (850) / 2700 (1482)3	5400 (2985)	1400 (760)	3200 (1760)	2300 (1260)			3000 (1371)	3000 (1371)	3200 (1760)		
CTE, in/in/°F x 10 ⁻⁶ (°C)		1.5 (2.7)	2.0 (3.6)	4.1 (7.4)	4.2 (7.6)	7.0 (12.6)	4.7 (8.5)	.33 (.59)	33 (.59) 2.4 (4.4) 4.1 (7.		4.5 (8.1) 4.0 (7.2)		4.0 (7.2)	
	Mix Ratio, powder:liquid	N/A	N/A	N/A	N/A	1.0:1.0 - 1.5:1.0	N/A	N/A	N/A	N/A	N/A	N/A	N/A	
	Thinner	865-T	690-T	Ethanol	669-T	571-T	632-T	618-N-T	890-T	516-T	685-N-T	835-T		
Handling	Solvent	Water	Water	Ethanol	Water	Water	Water	Water	Water	Water	Water	Water		
Han	Application Temperature, °F	50-90	50-90	40-90	50-90	50-90	50-90	50-90	50-90	50-90	50-90	50-90	50-90	
	Storage Temperature, °F	40-90	40-90	30-75	40-90	40-90	40-90	40-90	40-90	40-90	40-90	40-90	40-90	
	Shelf Life, Months	6	6	6	6	6	6	6	6	6	6	6	6	
	Air Set, Hours	1-4	1-4	1-4	1-4	1-4	1-4	1-4	<= 1	1-4	1-4	<= 1	<= 1	
Curing	Heat Cure, °F, Hrs	200, 2 + 350, 2 + 500, 2	200, 2 + 500, 2 + 700, 2	265,4 + 500,2	200,2	200,2	200, 2 + 500, 2	200, 2 + 500, 2 + 700, 2	200, 2 + 500, 2 + 700, 2	200, 2 + 500, 2 + 700, 2	200,2	200,2	500,2	
Dielectric Strength, volts/mil @ RT (@ 1000 °F)		187	208	75	105	91	150	156	73	188	176	111	105	
Torque Strength, ft-lbs ①		27	N/M	30 ^⑤	26	22	2	77	40	50	35	50	40	
Moi	sture Resistance ②	Excellent	Good	Excellent	Excellent	Excellent	Good	Excellent	Good	Good	Excellent	Good	Good	
Alka	li Resistance ②	Good	Good	Good	Good	Good	Good	Good	Good	Excellent	Good	Good	Good	
Acid	Resistance ②	Good	Good	Good	Good	Fair	Good	Good	Good	Good	Good	Good	Good	

Footnotes

- Tested using a torque wrench after bonding a pre-oxidized 1/2"-13 nut and bolt and final curing at 1000 °F.
 Properties were evaluated after curing at 700 °F for 2 hours.
 Ceramabond™ 690 operates to 1560 °F in an oxidizing atmosphere and 2700 °F in an inert or vacuum atmosphere.
 Graphi-Bond™ 551-RN is also offered in a two-part, resin and powder, system called 551-RN-X for international shipments of 1 gallon or more.
- ⑤ Graphi-Bond™ 551-RN also demonstrates a lap-shear strength of 770 psi.
- ® Ceramabond™ 571 ranges for viscosity and specific gravity reflect a powder-to-liquid mix ratio that ranges from 1-to-1 to 1.5-to-1.

Abbreviations

N/A - Not Applicable N/M – Not Measured

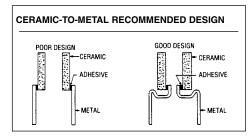
General Notes

- All adhesives except 551-RN contain no volatile organic compounds (VOCs).
- Special pigments available upon request.
- Some adhesives including 503, 516, 553, 569, 571, 618-N, and 890 can be formulated using 1-5 micron ceramic powders. Add "-VFG" to the part number (ex. 503-VFG) and contact Aremco for special pricing.

DESIGN GUIDELINES

General design criteria for bonding with ceramic and graphite adhesives are similar to those for epoxies and other organic adhesives. Main considerations include the coefficient of thermal expansion, joint design, glue line thickness, and operating environment.

Coefficient of Thermal Expansion



Due to the high thermal loading implicit in most ceramic adhesive applications, the joint design should account for the difference in the coefficient of thermal expansion

between the adhesive and the components that are being joined. In the illustration above, note that the "poor" design loads the adhesive in tension since the metal expands faster than the ceramic. The "good" design allows for this thermal mismatch and loads the adhesion in compression, offering higher reliability.

Joint Design

Most adhesives offer relatively poor tensile-shear strength, so it is important to design a joint that will distribute the mechanical stress by maximizing the length of the glue line as shown in this illustration.



Glue Line Thickness

The clearance between mating parts at operating temperature should be 2-8 mils (50-200 microns). Less than 2 mils will prevent uniform adhesion; greater than 8 mils will often result in cohesive shear failure within the adhesive. A maximum depth of 0.25" is recommended when using a ceramic or graphite adhesive for a small potting application.

Operating Environment

These adhesives offer excellent chemical, electrical and ultra high thermal resistance, and do not outgas under high vacuum. The main limitations are (a) relatively low mechanical strength and (b) slight porosity after curing. Contact Aremco for suggestions about how to reduce porosity and produce gas-tight seals.

APPLICATION PROCEDURES

Surface Preparation

Smooth surfaces are difficult to bond and should be etched, abrasive blasted or oxidized, then cleaned thoroughly prior to application. Aremco's Corr-Prep CPR2000 is recommended for etching metals. Porous substrates should be pre-coated with a binder to prevent separation and absorption of the adhesive binder. Add a "-T" to the part number (ex. 503-T) to designate the product thinner.

Mixing

One-part adhesives tend to settle and should be mixed thoroughly prior to use. Refer to Tech Bulletin A12 for information about Aremco's Model 7000 Pneumatic Mixer. Mix ratios for two-part adhesives are shown in the Property Chart. Viscosity may be adjusted by thinning up to 20% by weight.

Application

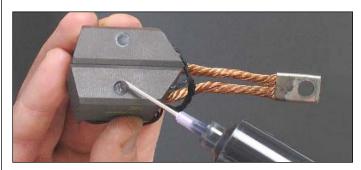
Apply a thin coat of adhesive to each surface using a brush, spatula or dispenser. Using a clamp or similar tool, maintain a uniform glue line of 2-8 mils (200-500 microns) by applying even pressure across the assembly. Wipe away excess material prior to drying. Refer to Tech Bulletin A12 for optional dispensing tools



Model 7000 Mixer

Curing

Refer to the Property Chart for specific curing instructions for each product.



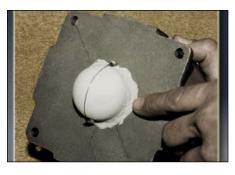
Graphi-Bond™ 551-RN seals sensor in carbon brushes.



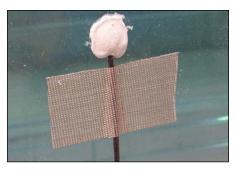
Ceramabond™ 569 bonds flex heater to quartz vessel.



Ceramabond $^{\text{TM}}$ 571 coats copper induction heater.



Ceramabond $^{\text{TM}}$ 571 coats oxygen sensor.



Ceramabond[™] 571 bonds thermocouple to glass.



Ceramabond[™] 618-N bonds porous ceramic filter elements.



Ceramabond[™] 671 used as a high temp threadlocker.



Ceramabond™ 503 repairs furnace saggar plate.



Ceramabond $^{\text{TM}}$ 685-N bonds ceramic gasket to metal door.



Cermabond™ 813-A seals tundish nozzle.



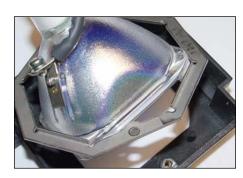
Ceramabond™ 835 bonds halogen lamp.



Ceramabond $^{\text{TM}}$ 552 seals thermocouple in metal housing.



Ceramabond™ 835-M bonds cover to halogen lamp.



Ceramabond™ 835-M bonds halogen lamp.

						CEF	RAM	IC F	ADHI	ESI	/E S	= =	CTO	R C	HAF	?T									
Material	CTE °F (°C)	503	552	569	670	671	813-A	835-M	835-MB	600	600-HV	668	677	865	690	551-RN	669	571	632	618-N	890	516	685-N	835	885
				-	Al	, O ₃	=	=	•		Al ₂ O ₃ -SiO ₂				AIN BN Graphite			MgO	Mica	SiO ₂	SiC		ZrO ₂ - ZrSiO ₄		
Alumina	4.4 (7.9)	•	•	•	•	•	•	•	•			X						Х							
Alumina-Silica	1.8 (3.2)									х	х	•	•												
Aluminum Nitride	1.5 (2.7)													•						х					
Beryllia	4.1 (7.4)	•	х	х	х	х	х	х														х	х	X	Х
Boron Carbide	2.6 (4.7)	х										х									Х				
Boron Nitride	4.2 (7.6)	Х													•										
Borosilicate Glass	1.8 (3.2)	Х																		•					
Calcium Silicate	3.0 (5.4)				•								х												
Ceramic Textile	-				•	Х																	х		
Cordierite	1.1 (2.0)																			•					
Graphite	4.3 (7.7)	X														•	•				X				
Macor	5.2 (9.4)		Х	•	Х	Х	Х	Х				Х						х	Х						
Mica	4.7 (8.5)																		•						
Mullite	3.0 (5.4)	X	Х	х	Х							•										Х	х	X	
Quartz	0.30 (0.54)	х		х				х	Х			х								•				X	
Refractory, Dense	-	•																			•				х
Refractory, Light Weight	-									•	•		•												
Sapphire	4.2 (7.6)	•		х	х			х	х			х													\vdash
Silica	0.31 (0.56)											х								•					t
Silicon Carbide	2.9 (5.2)	х																			•				\vdash
Silicon Nitride	1.8 (3.2)	х										х		х						х	х				\vdash
Steatite	4.0 (7.2)		х	•		х		х	х			х											х	•	$\overline{}$
Zirconia	5.7 (10.3)																					х	х	X	•
Zirconia Silicate	4.0 (7.2)																					•	•	•	х
Aluminum	15.0 (27.0)																	•							\vdash
Brass	10.2 (18.4)																	•							\vdash
Cast Iron	5.9 (10.6)		х	х	х	х	х	х				х						•	х				х		\vdash
Copper	9.3 (16.7)																	•							$\overline{}$
Inconel	6.4 (11.5)		х	х	х	х	х	х				х						•							\vdash
Molybdenum	2.9 (5.2)		х	•	х	х	х	х				•										х	х	X	T
Nickel	7.2 (13.0)																	•							\vdash
Nickel-Iron	2.6 (4.7)		х	•	х	Х	х	х				•										х	х	X	†
Platinum	4.9 (8.8)	•	Х	х	Х																				
Silicon	1.6 (2.9)											Х		х								х	х	X	
Silver	10.6 (19.1)																	х							
Stainless (300 Series)	9.6 (17.3)											Х						х							
Stainless (400 Series)	6.2 (11.2)		Х	х	X	Х	Х	Х				Х						•				Х	х	X	
Steel (1010)	6.5 (11.7)		Х	х	Х	Х	Х	Х				Х						•				Х	х	Х	
Tantalum	3.9 (7.0)		х	х	х	X	х	х				•						х				х	х	X	
Titanium	5.8 (10.4)		х	х	х	Х	х	х				х						•				х	х	X	1
Tungsten	2.5 (4.5)		х	•	х	Х	х	х				•										х	х	X	\vdash

^{• =} Preferred

x = Applicable